TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSVI)

2SK3561

Switching Regulator Applications

• Low drain-source ON resistance: RDS (ON) = 0.75Ω (typ.)

• High forward transfer admittance: $|Y_{fs}| = 6.5S$ (typ.)

• Low leakage current: IDSS = 100 μ A (VDS = 500 V)

• Enhancement mode: $V_{th} = 2.0 \sim 4.0 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA})$

Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	500	V	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	500	V	
Gate-source voltage		V _{GSS}	±30	V	
	DC (Note 1)	ID	8	А	
Drain current	Pulse (t = 1 ms) (Note 1)	I _{DP}	32		
Drain power dissipation (Tc = 25°C)		P _D	40	W	
Single pulse avalanche energy (Note 2)		E _{AS}	312	mJ	
Avalanche current		I _{AR}	8	Α	
Repetitive avalanche energy (Note 3)		E _{AR}	4	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	

Unit: mm \$\delta 3.2\to 0.2 \quad \text{10\to 0.3} \quad \text{A} \quad \text{V} \quad \quad \text{V} \quad \text{V} \quad \text{V} \quad \text{V} \quad \quad \text{V} \quad \text{V} \quad \text{V} \quad \quad \text{V} \quad \text{V} \quad \quad \text{V} \quad \quad \text{V} \quad \quad \text{V} \quad \

Weight: 1.7 g (typ.)

Thermal Characteristics

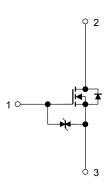
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	3.125	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C(initial), L = 8.3 mH, I_{AR} = 8 A, R_G = 25 Ω

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.



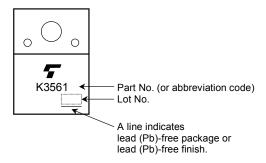
Electrical Characteristics (Ta = 25°C)

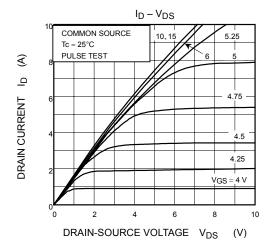
Chara	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I _{GSS}	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА
Gate-source brea	akdown voltage	V (BR) GSS	$I_G = \pm 10 \ \mu A, \ V_{DS} = 0 \ V$	±30	_	_	V
Drain cut-off curr	ent	I _{DSS}	V _{DS} = 500 V, V _{GS} = 0 V	_	_	100	μА
Drain-source bre	akdown voltage	V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	500	_	_	٧
Gate threshold vo	oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0	_	4.0	٧
Drain-source ON	resistance	R _{DS (ON)}	V _{GS} = 10 V, I _D = 4 A	_	0.75	0.85	Ω
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 4 A	3.0	6.5	_	S
Input capacitance	÷	C _{iss}		_	1050	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	_	10	_	pF
Output capacitance		C _{oss}			110	_	
Switching time	Rise time	t _r	V_{GS} $V_{DD} \approx 200 \text{ V}$	_	26		ns
	Turn-on time	t _{on}			45		
	Fall time	t _f		_	38	_	
	Turn-off time	t _{off}	Duty ≦ 1%, t _W = 10 μs	_	130	_	
Total gate charge		Qg		_	28	_	
Gate-source charge		Q _{gs}	$V_{DD} \simeq 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 8 \text{ A}$	_	16	_	nC
Gate-drain charge		Q _{gd}]	_	12	_	

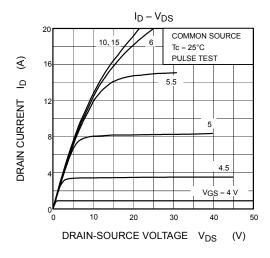
Source-Drain Ratings and Characteristics (Ta = 25°C)

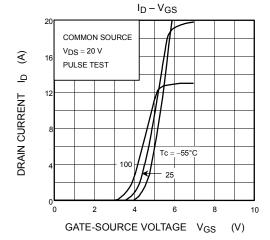
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	8	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	32	Α
Forward voltage (diode)	V _{DSF}	$I_{DR} = 8 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	-1.7	V
Reverse recovery time	t _{rr}	$I_{DR} = 8 \text{ A}, V_{GS} = 0 \text{ V},$	_	1200	_	ns
Reverse recovery charge	Q _{rr}	dI _{DR} /dt = 100 A/μs	_	10	_	μС

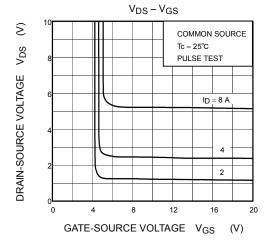
Marking

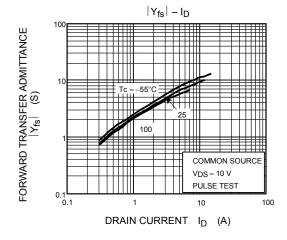


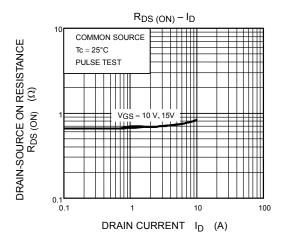


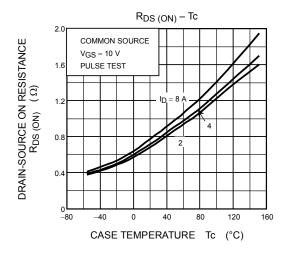


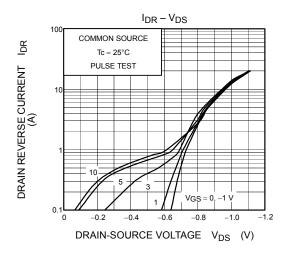


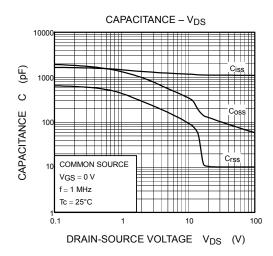


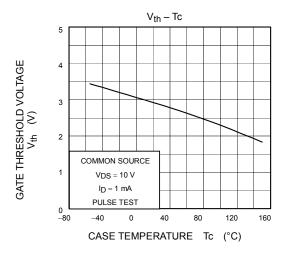


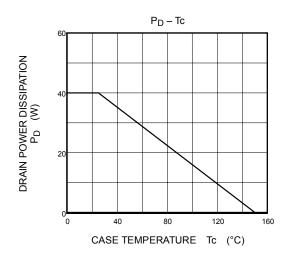


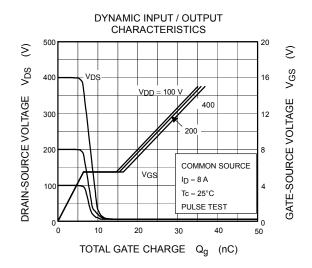


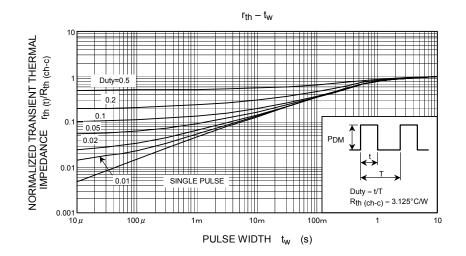


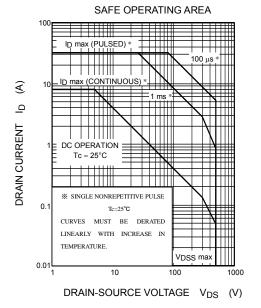


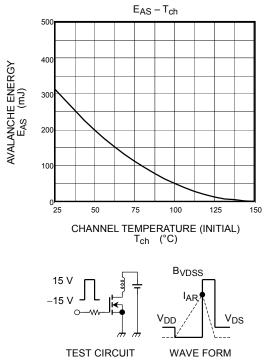












$$R_G = 25 \Omega$$

 $V_{DD} = 90 \text{ V, } L = 8.3 \text{mH}$ $V_{DD} = \frac{1}{2} \cdot L \cdot l^2 \cdot \left(\frac{1}{B}\right)$

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